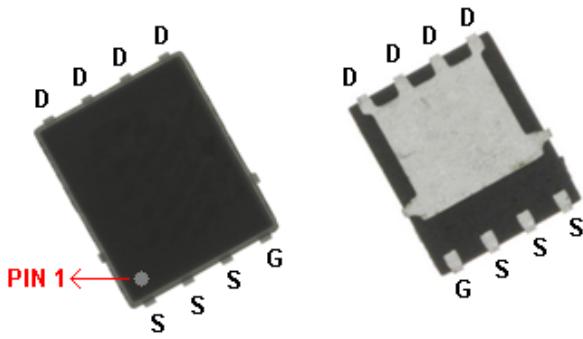


**N-Channel 30V(D-S) Enhancement MOSFET**
**GENERAL DESCRIPTION**

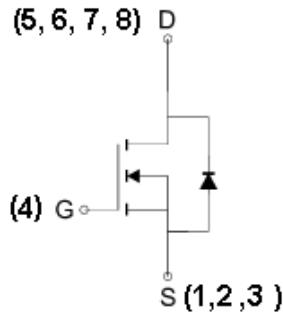
The ME7688 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as notebook computer power management and other battery powered circuits where Low-side switching , and low in-line power loss are needed in a very small outline surface mount package.

**PIN CONFIGURATION**
**PowerDFN 5x6**

**FEATURES**

- $R_{DS(ON)} \leq 11\text{m}\Omega @ V_{GS}=10\text{V}$
- $R_{DS(ON)} \leq 19.5\text{m}\Omega @ V_{GS}=4.5\text{V}$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

**APPLICATIONS**

- Power Management in Note book
- NB/MB Vcore Low side switching
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch


**Ordering Information:** ME7688 (Pb-free)

ME7688-G (Green product-Halogen free)

**N-Channel MOSFET**
**Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  Unless Otherwise Noted)**

Parameter	Symbol	Maximum Ratings	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain*	$I_D$	46.4	A
		37.1	
		12.6	
		10.1	
Pulsed Drain Current	$I_{DM}$	50	A
Maximum Power Dissipation*	$P_D$	37.9	W
		24.2	
		2.8	
		1.8	
Operating Junction Temperature	$T_J$	-55 to 150	$^\circ\text{C}$
Thermal Resistance-Junction to Ambient*	$R_{\theta JA}$	45	$^\circ\text{C}/\text{W}$
Thermal Resistance-Junction to Case*	$R_{\theta JC}$	3.3	$^\circ\text{C}/\text{W}$

\*The device mounted on 1in<sup>2</sup> FR4 board with 2 oz copper

**N-Channel 30V(D-S) Enhancement MOSFET**
**Electrical Characteristics (TA=25°C Unless Otherwise Specified)**

Symbol	Parameter	Limit	Min	Typ	Max	Unit
<b>STATIC</b>						
V(BR)DSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250 μA	30			V
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250 μA	1		3	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μA
R <sub>D(S(ON))</sub>	Drain-Source On-State Resistance <sup>a</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =15A		9	11	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =12A		15	19.5	
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =15A, V <sub>GS</sub> =0V		0.9	1.2	V
<b>DYNAMIC</b>						
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =15V, V <sub>GS</sub> =10V, I <sub>D</sub> =15A		18		nC
Q <sub>g</sub>	Total Gate Charge			9		
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =15V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =15A		4.3		
Q <sub>gd</sub>	Gate-Drain Charge			3.3		
C <sub>iss</sub>	Input Capacitance			695		pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, F=1MHz		151		
C <sub>rss</sub>	Reverse Transfer Capacitance			47		
R <sub>g</sub>	Gate-Resistance	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, F=1MHz		1.5		Ω
t <sub>d(on)</sub>	Turn-On Delay Time			14		ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>DD</sub> =15V, R <sub>L</sub> =15Ω		13		
t <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =1A, V <sub>GEN</sub> =10V		42		
t <sub>f</sub>	Turn-Off Fall Time	R <sub>G</sub> =6Ω		7		

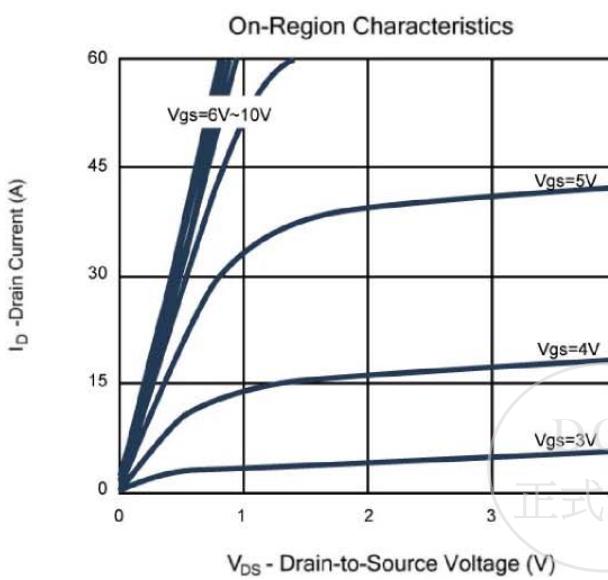
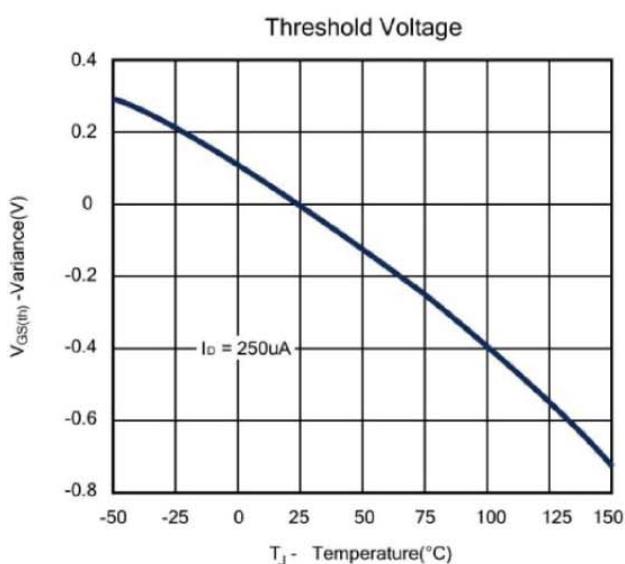
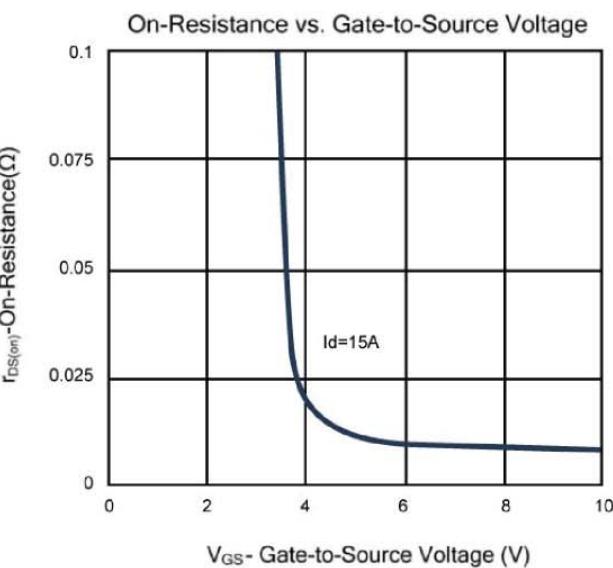
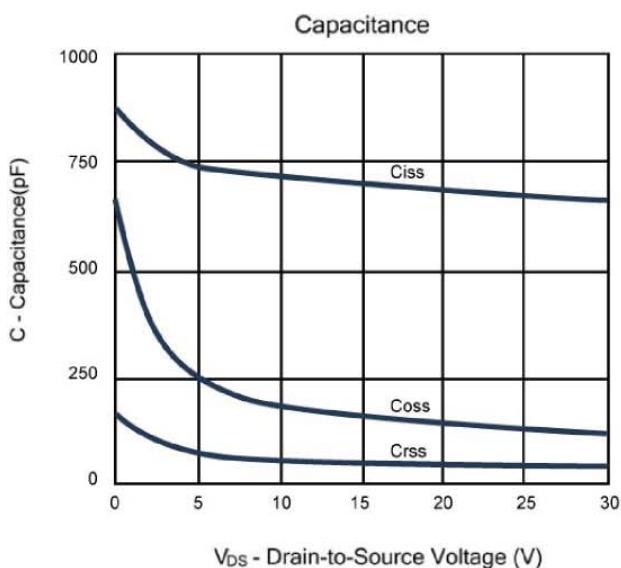
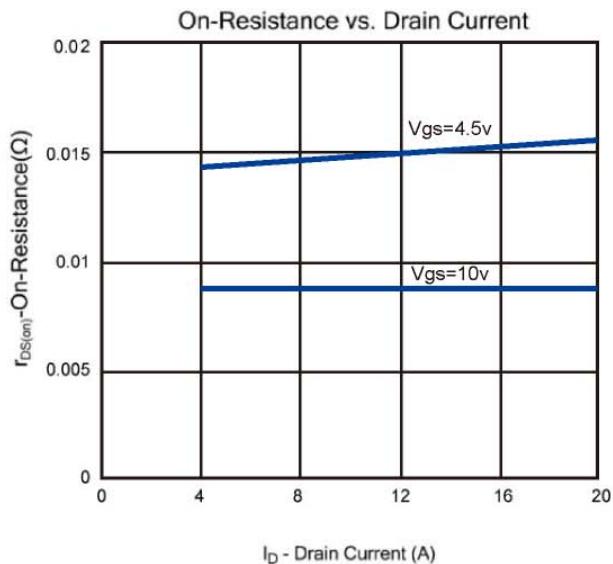
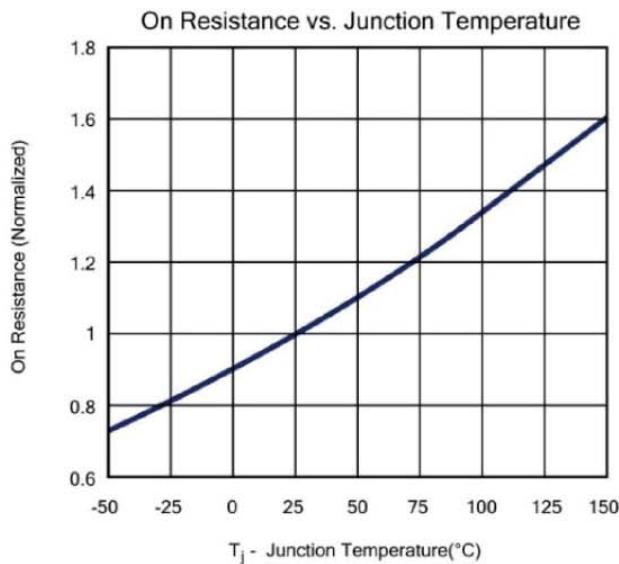
Note: a. Pulse test: pulse width ≤ 300us, duty cycle ≤ 2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



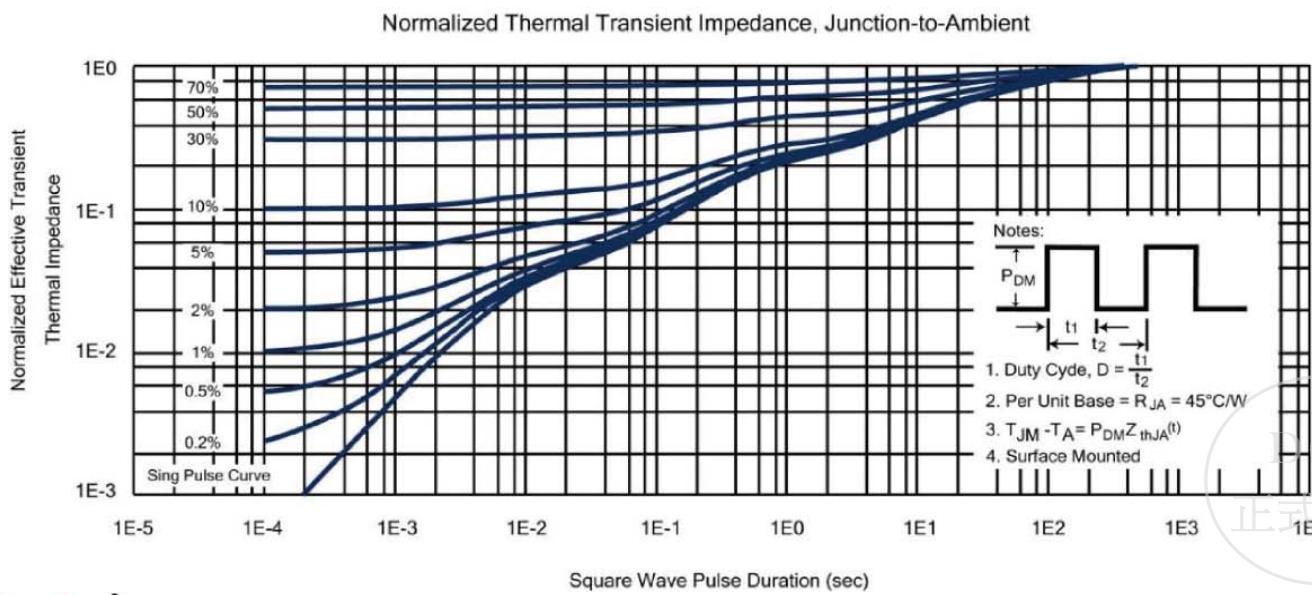
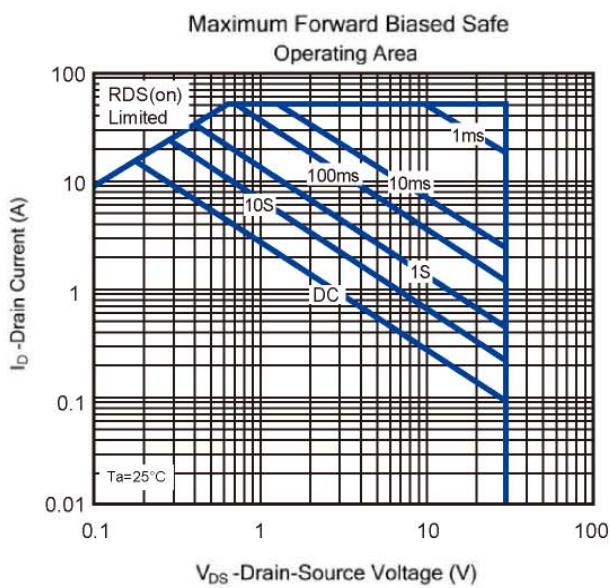
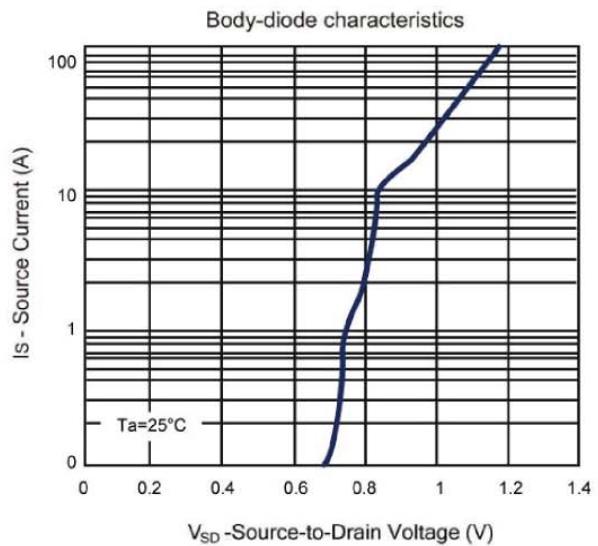
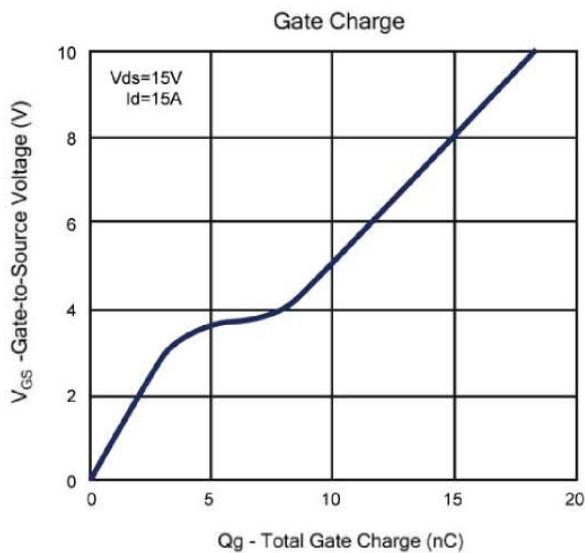
**N-Channel 30V(D-S) Enhancement MOSFET**

**Typical Characteristics (T<sub>J</sub> =25°C Noted)**

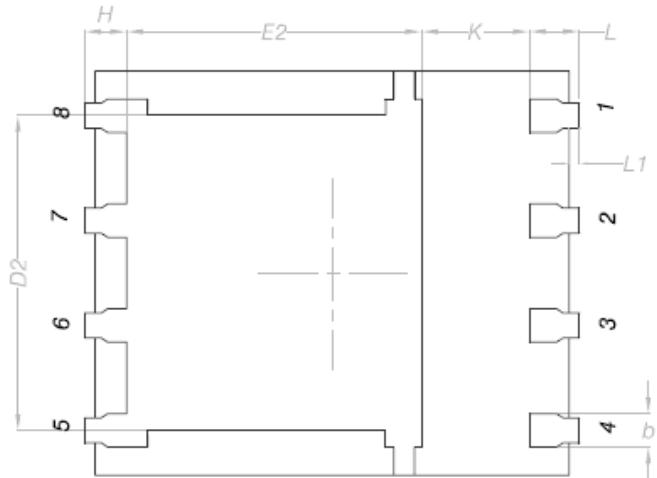


N-Channel 30V(D-S) Enhancement MOSFET

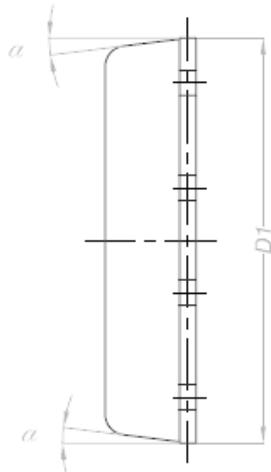
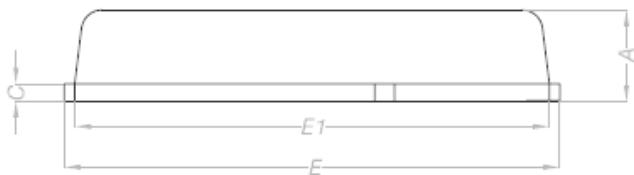
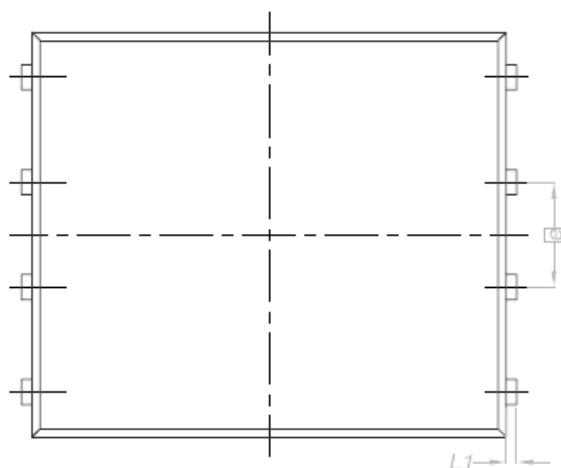
Typical Characteristics (T<sub>J</sub> = 25°C Noted)



### PowerDFN5x6 Package Outline



BACKSIDE VIEW



SYMBOL	MILLIMETERS (mm)	
	MIN	MAX
A	0.90	1.10
b	0.33	0.51
C	0.20	0.30
D1	4.80	5.00
D2	3.61	3.96
E	5.90	6.10
E1	5.70	5.80
E2	3.38	3.78
e	1.27 BSC	
H	0.41	0.61
K	1.10	-
L	0.51	0.71
L1	0.06	0.20
α	0°	12°

